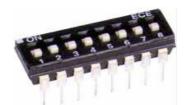


EAH SERIES AUTO INSERTING TYPE





FEATURES

- Same size with IC, can be assembled by any automatic IC inserter.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Twin contacts designed to ensure stable contact.
- Gold plated contact to ensure low contact resistance and Tin plated terminals to prevent contamination during soldering.

SPECIFICATIONS

1.ELECTRICAL

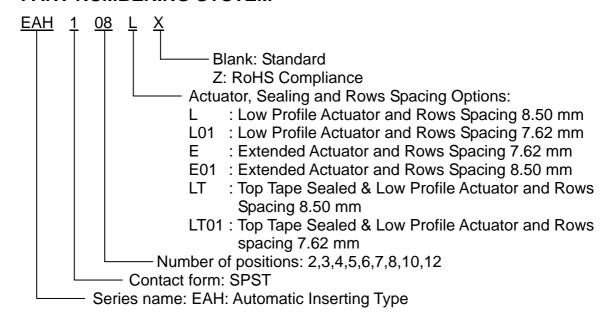
Contact rating		
switching	25mA, 24VDC	
non-switching	100mA	
Contact resistance		
initial	50m Max.	
after life test	100m Max.	
 Insulation resistance 	1000M Min. at 100VDC	
Dielectric strength	500VDC Min. for 60 seconds	
Capacitance between adjacent switches 5pF Max.		



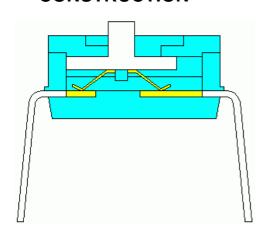
2.MECHANICAL and ENVIRONMENTAL

Temperature rating				
operating	-25 to +70			
storage	-40 to +85			
Operation force	800g Max.			
Mechanical life	2000 operations			
Humidity	95 % RH, 40 for 96 Hrs.			
Vibration	Per MIL-STD-202F, method 204D.			
 Solderability 	after flux 230±5 for 5±0.5 seconds, 95 % coverage			
Resistance to soldering heat	260±5 for 5±1 seconds.			

PART NUMBERING SYSTEM



CONSTRUCTION





OPTIONS

- Special marking and case color available upon request
- 2. Two kinds of pitch available

2. The imide of phon available			
Actuator	Pitch(mm)		
	Standard	Option	
L	8.50	7.62	
Е	7.62	8.50	



4. Tape Sealed





DIMENSIONS AND CIRCUITRY

